# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3335107

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
DAN CAROTHERS	04/20/2015
RAJARSHI MUKHOPADHYAY	04/21/2015
PAUL BROHLIN	04/23/2015
BENJAMIN COOK	04/22/2015

### **RECEIVING PARTY DATA**

Name:	TEXAS INSTRUMENTS INCORPORATED
Street Address:	12500 TI BOULEVARD
Internal Address:	M/S 3999
City:	DALLAS
State/Country:	TEXAS
Postal Code:	75243

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14701484

### **CORRESPONDENCE DATA**

**Fax Number:** (214)567-2228

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 214-479-1243

**Email:** uspto@ti.com, swalsh@ti.com

Correspondent Name: TEXAS INSTRUMENTS INCORPORATED

Address Line 1: 12500 TI BOULEVARD

Address Line 2: M/S 3999

Address Line 4: DALLAS, TEXAS 75243

NAME OF SUBMITTER: SHAWN T. WALSH SIGNATURE: /Shawn T. Walsh/ DATE SIGNED: 04/30/2015	ATTORNEY DOCKET NUMBER:	TI-75685
	NAME OF SUBMITTER:	SHAWN T. WALSH
<b>DATE SIGNED:</b> 04/30/2015	SIGNATURE:	/Shawn T. Walsh/
<b>]</b>	DATE SIGNED:	04/30/2015

**Total Attachments: 4** 

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WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made.

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 12500 TI Boulevard, M/S 3999, Dallas, Texas 75243, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon, as well as to U.S. Provisional Application No(s). 62/108,799, filed 01/28/2015;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign unto the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in and to the said application(s) and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Patent and Trademark Office to issue all patents for said invention, or patents resulting therefrom, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my corresponding rights to the invention disclosed in said application in all other countries of the world, including the right to claim priority, file applications and obtain patents under the terms of the Paris Convention for the Protection of Industrial Property, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful paths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

I authorize the later insertion of the nonprovisional application number and filing date hereinbelow.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE	WAFER SUBSTRATE REMOVAL
NONPROVISIONAL APPLICATION NO.	FILING DATE
SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	Dan Carothers 4/20/c
DATE	
RESIDENCE (CITY AND STATE)	Lucas TX,

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made.

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 12500 TI Boulevard, M/S 3999, Dallas, Texas 75243, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon, as well as to U.S. Provisional Application No(s). 62/108.799, filed 01/28/2015;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign unto the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in and to the said application(s) and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof, and I hereby authorize and request the Patent and Trademark Office to issue all patents for said invention, or patents resulting therefrom, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my corresponding rights to the invention disclosed in said application in all other countries of the world, including the right to claim priority, file applications and obtain patents under the terms of the Paris Convention for the Protection of Industrial Property, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

I authorize the later insertion of the nonprovisional application number and filing date hereinbelow.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE	WAFER SUBSTRATE REMOVA		
NONPROVISIONAL APPLICATION NO.		FILING DATE	

SIGNATURE OF INVENTOR	Kijadii Mubhapadhyay
PRINTED NAME OF INVENTOR	Rajarshi Mukhopadhyay
DATE	04/21/2015
RESIDENCE (CITY AND STATE)	Allen, TX

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made.

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 12500 TI Boulevard, M/S 3999, Dallas, Texas 75243, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon, as well as to U.S. Provisional Application No(s). 62/108,799, filed 01/28/2015;

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I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my corresponding rights to the invention disclosed in said application in all other countries of the world, including the right to claim priority, file applications and obtain patents under the terms of the Paris Convention for the Protection of Industrial Property, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such rights.

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I authorize the later insertion of the nonprovisional application number and filing date hereinbelow

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year,

TITLE	WAFER SUBSTRATE REMOVAL	
NONPROVISIONAL APPLICATION NO.	FILING DATE	
SIGNATURE OF INVENTOR	Part Bille	
PRINTED NAME OF INVENTOR	Paul Brohlin	
DATE	23 April 2015	
RESIDENCE (CITY AND STATE)	Parker, TX	

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made.

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 12500 TI Boulevard, M/S 3999, Dellas, Texas 75243, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon, as well as to U.S. Provisional Application No(s). 62/108,799, filed 01/28/2015;

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I authorize the later insertion of the nonprovisional application number and filing date hereinbelow

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TITLE	WAFER SUBSTRATE REMOVAL
NONPROVISIONAL APPLICATION NO.	FILING DATE
SIGNATURE OF INVENTOR	12-
PRINTED NAME OF INVENTOR	Benjamin Cook
DATE	4/22/2015
RESIDENCE (CITY AND STATE)	Dallas, TX

PATENT REEL: 035542 FRAME: 0192

RECORDED: 04/30/2015